



CYPRESS

2.5V or 3.3V, 200-MHz, 1:15 Clock Distribution Buffer

CY29949

Features

- 2.5V or 3.3V operation
- 200-MHz clock support
- LVPECL or LVCMOS/LVTTL clock input
- LVCMOS-/LVTTL-compatible outputs
- 15 clock outputs: drive up to 30 clock lines
- 1X and 1/2X configurable outputs
- Output three-state control
- 350 ps max. output-to-output skew
- Pin compatible with MPC949, MPC9449
- Available in Commercial and Industrial temp. range
- 52-pin TQFP package

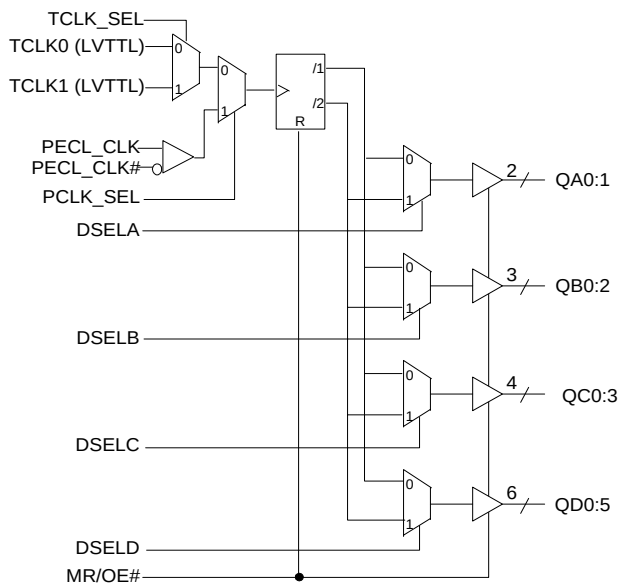
Description

The CY29949 is a low-voltage 200-MHz clock distribution buffer with the capability to select either a differential LVPECL or LVCMOS/LVTTL compatible input clocks. These clock sources can be used to provide for test clocks as well as the primary system clocks. All other control inputs are LVCMOS/LVTTL compatible. The 15 outputs are LVCMOS or LVTTL compatible and can drive 50Ω series or parallel terminated transmission lines. For series terminated transmission lines, each output can drive one or two traces giving the device an effective fanout of 1:30.

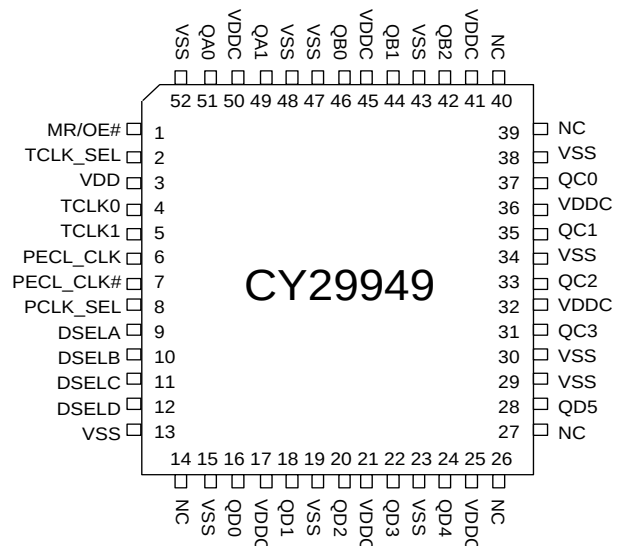
The CY29949 is capable of generating 1X and 1/2X signals from a 1X source. These signals are generated and retimed internally to ensure minimal skew between the 1X and 1/2X signals. SEL(A:D) inputs allow flexibility in selecting the ratio of 1X to 1/2X outputs.

The CY29949 outputs can also be three-stated via the MR/OE# input. When MR/OE# is set HIGH, it resets the internal flip-flops and three-states the outputs.

Block Diagram



Pin Configuration



Pin Description^[1]

Pin	Name	PWR	I/O	Description
6	PECL_CLK		I, PD	PECL Input Clock
7	PECL_CLK#		I, PU	PECL Input Clock
4, 5	TCLK(0,1)		I, PU	External Reference/Test Clock Input
49, 51	QA(1,0)	VDDC	O	Clock Outputs
42, 44, 46	QB(2:0)	VDDC	O	Clock Outputs
31, 33, 35, 37	QC(3:0)	VDDC	O	Clock Outputs
16, 18, 20, 22, 24, 28	QD(5:0)	VDDC	O	Clock Outputs
9, 10, 11, 12	DSEL(A:D)		I, PD	Divider Select Inputs. When HIGH, selects ÷2 input divider. When LOW, selects ÷1 input divider.
2	TCLK_SEL		I, PD	TCLK Select Input. When LOW, TCLK0 clock is selected and when HIGH TCLK1 is selected.
8	PCLK_SEL		I, PD	PECL Select Input. When HIGH, PECL clock is selected and when LOW TCLK(0,1) is selected
1	MR_OE#		I, PD	Output Enable Input. When asserted LOW, the outputs are enabled and when asserted HIGH, internal flip-flops are reset and the outputs are three-stated.
17, 21, 25, 32, 36, 41, 45, 50	VDDC			2.5V or 3.3V Power Supply for Output Clock Buffers
3	VDD			2.5V or 3.3V Power Supply
13, 15, 19, 23, 29, 30, 34, 38, 43, 47, 48, 52	VSS			Common Ground
14, 26, 27, 39, 40,	NC			Not Connected

Note:

1. PD = internal pull-down, PU = internal pull-up.

Maximum Ratings ^[2]

Maximum Input Voltage Relative to V_{SS} : $V_{SS} - 0.3V$
 Maximum Input Voltage Relative to V_{DD} : $V_{DD} + 0.3V$
 Storage Temperature: $-65^{\circ}C$ to $+150^{\circ}C$
 Operating Temperature: $-40^{\circ}C$ to $+85^{\circ}C$
 Maximum ESD Protection 2 kV
 Maximum Power Supply: 5.5V
 Maximum Input Current: ± 20 mA

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation, V_{in} and V_{out} should be constrained to the range:

$$V_{SS} < (V_{in} \text{ or } V_{out}) < V_{DD}$$

Unused inputs must always be tied to an appropriate logic voltage level (either V_{SS} or V_{DD}).

DC Parameters: $V_{DD} = V_{DDC} = 3.3V \pm 10\%$ or $2.5V \pm 5\%$, Over the specified temperature range

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
V_{IL}	Input Low Voltage	$V_{DD} = 3.3V$, PECL_CLK single ended	1.49		1.825	V
		$V_{DD} = 2.5V$, PECL_CLK single ended	1.10		1.45	
		All other inputs	V_{SS}		0.8	
V_{IH}	Input High Voltage	$V_{DD} = 3.3V$, PECL_CLK single ended	2.135		2.42	V
		$V_{DD} = 2.5V$, PECL_CLK single ended	1.75		2.0	
		All other inputs	2.0		V_{DD}	
I_{IL}	Input Low Current ^[3]				-100	μA
I_{IH}	Input High Current ^[3]				100	
V_{PP}	Peak-to-Peak Input Voltage PECL_CLK		300		1000	mV
V_{CMR}	Common Mode Range ^[4] PECL_CLK	$V_{DD} = 3.3V$	$V_{DD} - 2.0$		$V_{DD} - 0.6$	V
		$V_{DD} = 2.5V$	$V_{DD} - 1.2$		$V_{DD} - 0.6$	
V_{OL}	Output Low Voltage ^[5]	$I_{OL} = 20$ mA			0.4	V
V_{OH}	Output High Voltage ^[5]	$I_{OH} = -20$ mA, $V_{DD} = 3.3V$	2.5			V
		$I_{OH} = -20$ mA, $V_{DD} = 2.5V$	1.8			
I_{DDQ}	Quiescent Supply Current			5	7	mA
I_{DD}	Dynamic Supply Current	$V_{DD} = 3.3V$, Outputs @ 100 MHz, CL = 30 pF		200		mA
		$V_{DD} = 3.3V$, Outputs @ 160 MHz, CL = 30 pF		330		
		$V_{DD} = 2.5V$, Outputs @ 100 MHz, CL = 30 pF		140		
		$V_{DD} = 2.5V$, Outputs @ 160 MHz, CL = 30 pF		235		
Z_{out}	Output Impedance	$V_{DD} = 3.3V$	12	15	18	Ω
		$V_{DD} = 2.5V$	14	18	22	
C_{in}	Input Capacitance			4		pF

Notes:

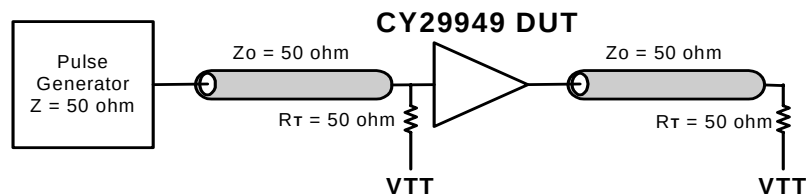
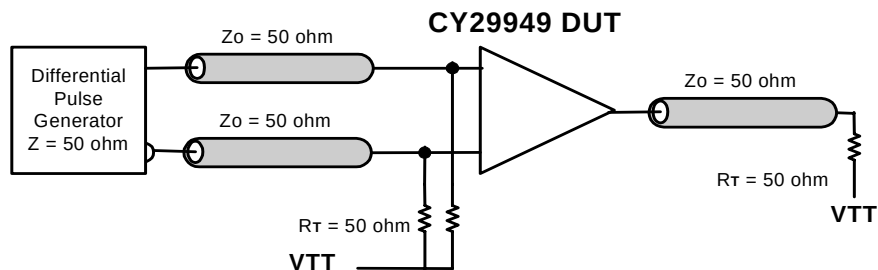
2. **Multiple Supplies:** The voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.
3. Inputs have pull-up/pull-down resistors that effect input current.
4. The V_{CMR} is the difference from the most positive side of the differential input signal. Normal operation is obtained when the "High" input is within the V_{CMR} range and the input lies within the V_{PP} specification.
5. Driving series or parallel terminated 50 Ω (or 50 Ω to $V_{DD}/2$) transmission lines.

AC Parameters^[6]: $V_{DD} = V_{DDC} = 3.3V \pm 10\%$ or $2.5V \pm 5\%$, Over the specified temperature range

Parameter	Description	Conditions	Min.	Typ.	Max.	Unit
Fmax	Input Frequency ^[7]	$V_{DD} = 3.3V$			200	MHz
		$V_{DD} = 2.5V$			170	
Tpd	PECL_CLK to Q Delay ^[7]	$V_{DD} = 3.3V$	4.0		8.6	ns
	TCLK to Q Delay ^[7]		4.2		10.5	
	PECL_CLK to Q Delay ^[7]	$V_{DD} = 2.5V$	6.0		10.6	
	TCLK to Q Delay ^[7]		6.2		10.5	
FoutDC	Output Duty Cycle ^[7, 8]	Measured at $V_{DD}/2$	45		55	%
tpZL, tpZH	Output Enable Time (all outputs)		2		10	ns
tpLZ, tpHZ	Output Disable Time (all outputs)		2		10	ns
Tskew	Output-to-Output Skew ^[7, 9]			250	350	ps
Tskew(pp)	Part-to-Part Skew ^[10]	PECL_CLK to Q		1.5	2.75	ns
		TCLK to Q		2.0	4.0	
Tr/Tf	Output Clocks Rise/Fall Time ^[9]	0.8V to 2.0V, $V_{DD} = 3.3V$	0.10		1.0	ns
		0.6V to 1.8V, $V_{DD} = 2.5V$	0.10		1.3	

Notes:

6. Parameters are guaranteed by design and characterization. Not 100% tested in production. All parameters specified with loaded outputs.
7. Outputs driving 50 Ω transmission lines.
8. 50% input duty cycle.
9. See Figures 1 and 2.
10. Part-to-Part skew at a given temperature and voltage.


Figure 1. LVCMOS_CLK CY29949 Test Reference for $V_{CC} = 3.3V$ and $V_{CC} = 2.5V$

Figure 2. PECL_CLK CY29949 Test Reference for $V_{CC} = 3.3V$ and $V_{CC} = 2.5V$

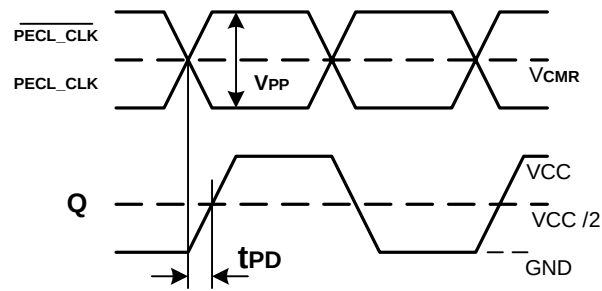


Figure 3. Propagation Delay (TPD) Test Reference

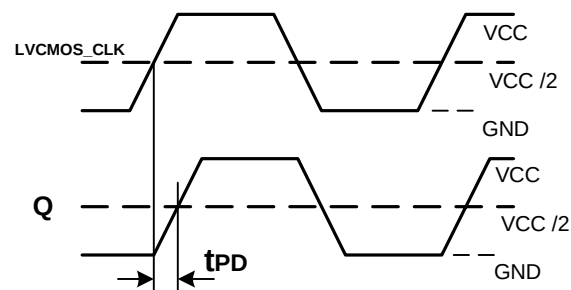


Figure 4. LVCMOS Propagation Delay (TPD) Test Reference

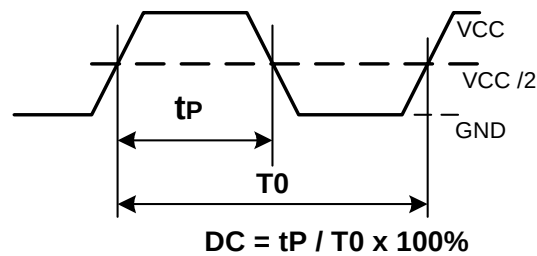


Figure 5. Output Duty Cycle (FoutDC)

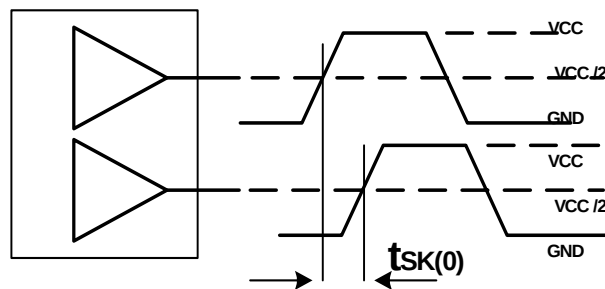


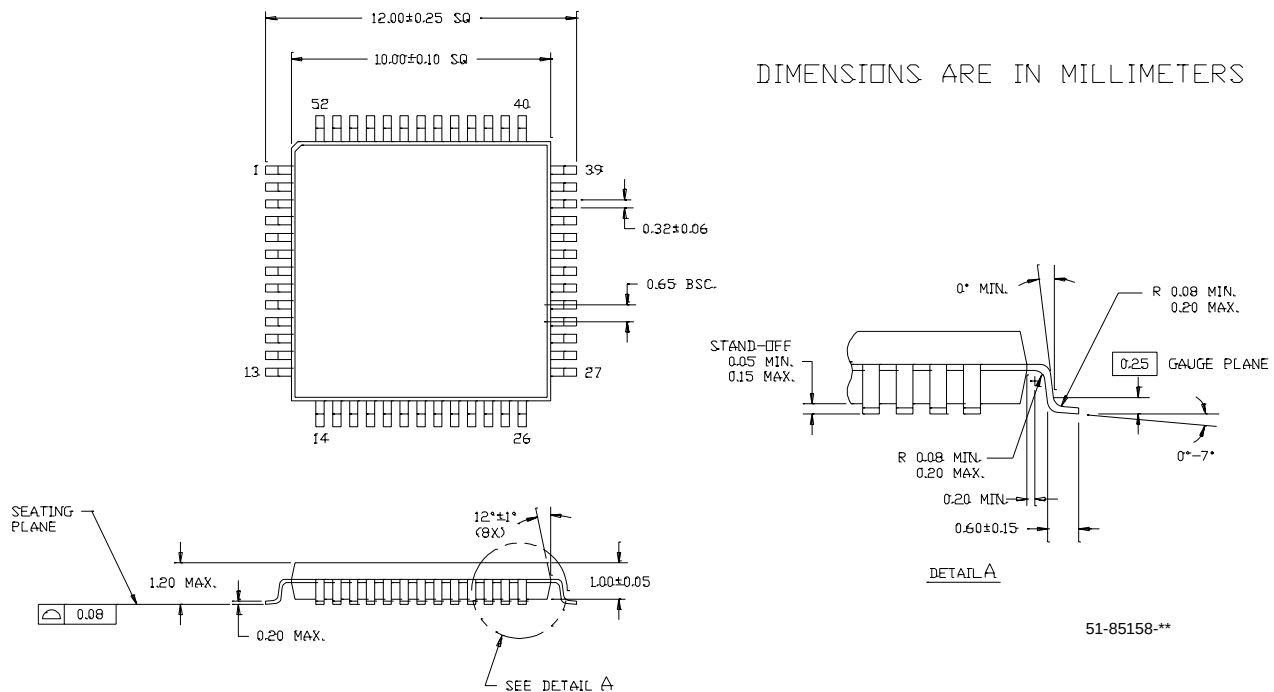
Figure 6. Output-to-Output Skew tsk(0)

Ordering Information

Part Number	Package Type	Production Flow
CY29949AI	52 Pin TQFP	Industrial, -40°C to +85°C
CY29949AIT	52 Pin TQFP - Tape and Reel	Industrial, -40°C to +85°C
CY29949AC	52 Pin TQFP	Commercial, 0°C to +70°C
CY29949ACT	52 Pin TQFP - Tape and Reel	Commercial, 0°C to +70°C

Package Drawing and Dimensions

52-Lead Thin Plastic Quad Flat Pack (10 x 10 x 1.0 mm) A52B



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Revision History

Document Title: CY29949 2.5V or 3.3V, 200-MHz, 1:15 Clock Distribution Buffer Document Number: 38-07289				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	111100	02/01/02	BRK	New data sheet
*A	116783	08/14/02	HWT	Added Commercial Temp. Range in the ordering Information
*B	118463	09/09/02	HWT	Corrected the Package Drawing and Dimension in page 6 from 52 LQFP to 52 TQFP
*C	122881	12/22/02	RBI	Added power up requirements to Maximum Ratings